Duplicate of IDS submitted 02/14/2005; considered by Examiner and returned to

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Substitute for form 1449A/PTO Complete if Known INFORMATION DESCLOSURE **Application Number** 09/945535 STATEMENT BY APPLICANT (Use as many sheets as recessary) Filing Date August 30, 2001 JUN 1 2 2003 **First Named Inventor** Ahn, Kie **Group Art Unit** 2813 m **Examiner Name** Blum, David Attorney Docket No: 1303.026US1 Sheet 1 of 3

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